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DS1488N

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DS1488 Quad Line Driver

Check for Samples: DS1488

FEATURES

- Current Limited output: ±10 mA Typ
- Power-Off Source Impedance: 300Ω Min
- Simple Slew Rate Control with External Capacitor
- Flexible Operating Supply Range
- Inputs are TTL/LS Compatible

Schematic and Connection Diagrams

DESCRIPTION

The DS1488 is a quad line driver which converts standard TTL input logic levels through one stage of inversion to output levels which meet EIA Standard RS-232D and CCITT Recommendation V.24.

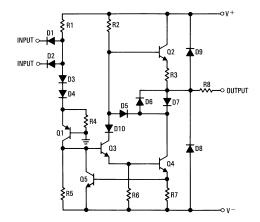


Figure 1. 1/4 Circuit

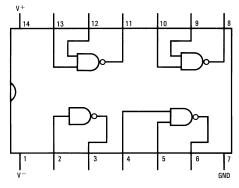


Figure 2. Small-Outline or Dual-In-Line Package (Top View) SOIC Package, See Package Number D PDIP Package, See Package Number NFF



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

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1280 mW

974 mW

260°C

Absolute Maximum Rating	S ⁽¹⁾⁽²⁾	
Complex Valtages	V ⁺	+15V
Supply Voltage	V ⁻	−15V
Input Voltage (V _{IN})		-15V ≤ V _{IN} ≤ 7.0V
Output Voltage		±15V
Operating Temperature Range		0°C to +75°C
Storage Temperature Range		−65°C to +150°C

Lead Temperature (Soldering, 4 sec.)

(1) Absolute Maximum Ratings are those values beyond which the safety of the device cannot be ensured. Except for "Operating Temperature Range" they are not meant to imply that the devices should be operated at these limits. The table of "Electrical Characteristics" provides conditions for actual device operation.

Molded PDIP Package

SOIC Package

(2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.

(3) Derate molded PDIP package 10.2 mW/°C above 25°C; derate SOIC package 7.8 mW/°C above 25°C.

Electrical Characteristics (1)(2)

Maximum Power Dissipation at 25°C (3)

 V_{CC} + = 9V, V_{CC} - = -9V unless otherwise specified

Symbol	Parameter		Conditions	Min	Тур	Max	Units
I _{IL}	Logical "0" Input Current	$V_{IN} = 0V$	V _{IN} = 0V		-0.8	-1.3	mA
I _{IH}	Logical "1" Input Current	V _{IN} = +5.0V			0.005	10.0	μA
V _{OH}	High Level Output Voltage	$R_L = 3.0 \text{ k}\Omega,$ $V_{IN} = 0.8 \text{V}$	V ⁺ = 9.0V, V [−] = −9.0V	6.0	7.1		V
			$V^+ = 13.2V, V^- = -13.2V$	9.0	10.7		V
V _{OL}	Low Level Output Voltage	$R_L = 3.0 \text{ k}\Omega,$ $V_{IN} = 1.9 \text{V}$	$V^{+} = 9.0V, V^{-} = -9.0V$	-6.0	7.0		V
			$V^+ = 13.2V, V^- = -13.2V$	-9.0	-10.6		V
I _{OS} +	High Level Output	V _{OUT} = 0V, V _{IN} = 0.8V		-6.0	-10.0	-12.0	mA
	Short-Circuit Current						
I _{OS} -	Low Level Output	V 0V V 4 0V		6.0	10.0	12.0	mA
	Short-Circuit Current	$v_{OUT} = uv, v_{IN}$	$V_{OUT} = 0V, V_{IN} = 1.9V$				
R _{OUT}	Output Resistance	$V^{+} = V^{-} = 0V, V_{OUT} = \pm 2V$		300			Ω
I _{CC} +	Positive Supply Current (Output Open)	V _{IN} = 1.9V	V ⁺ = 9.0V, V [−] = −9.0V		11.6	20.0	mA
			$V^+ = 12V, V^- = -12V$		15.7	25.0	mA
			$V^+ = 15V, V^- = -15V$		19.4	34.0	mA
		V _{IN} = 0.8V	$V^{+} = 9.0V, V^{-} = -9.0V$		3.4	6.0	mA
			$V^+ = 12V, V^- = -12V$		4.1	7.0	mA
			$V^+ = 15V, V^- = -15V$		9.1	12.0	mA
I _{CC} -	Negative Supply Current (Output Open)	V _{IN} = 1.9V	$V^{+} = 9.0V, V^{-} = -9.0V$		-10.8	-17.0	mA
			$V^+ = 12V, V^- = -12V$		-14.6	-23.0	mA
			V ⁺ = 15V, V [−] = −15V		-18.3	-34.0	mA
		$V^{+} = 9.0V, V^{-} = -9.0V$ $V^{+} = 12V, V^{-} = -12V$ $V^{+} = 15V, V^{-} = -15V$	V ⁺ = 9.0V, V [−] = −9.0V		-0.001	-0.100	mA
			V ⁺ = 12V, V [−] = −12V		-0.001	-0.100	mA
			V ⁺ = 15V, V [−] = −15V		-0.01	-2.5	mA
P _d	Power Dissipation	V ⁺ = 9.0V, V ⁻ =	-9.0V		252	333	mW
		$V^{+} = 12V, V^{-} = 10$	-12V		444	576	mW

(1) Unless otherwise specified min/max limits apply across the 0°C to +75°C temperature range for the DS1488.

(2) All currents into device pins shown as positive, out of device pins as negative, all voltages referenced to ground unless otherwise noted. All values shown as max or min on absolute value basis.

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Switching Characteristics

 $(V_{CC} = 9V, V_{EE} = -9V, T_A = 25^{\circ}C)$

Symbol	Parameter	Conditions	Min	Тур	Max	Units
t _{pd1}	Propagation Delay to a Logical "1"	$R_L = 3.0 \text{ k}\Omega, C_L = 15 \text{ pF}, T_A = 25^{\circ}\text{C}$		187	350	ns
t _{pd0}	Propagation Delay to a Logical "0"	$R_L = 3.0 \text{ k}\Omega, C_L = 15 \text{ pF}, T_A = 25^{\circ}\text{C}$		45	175	ns
t _r	Rise Time	$R_L = 3.0 \text{ k}\Omega, C_L = 15 \text{ pF}, T_A = 25^{\circ}\text{C}$		63	100	ns
t _f	Fall Time	$R_L = 3.0 \text{ k}\Omega, C_L = 15 \text{ pF}, T_A = 25^{\circ}\text{C}$		33	75	ns

Applications

By connecting a capacitor to each driver output the slew rate can be controlled utilizing the output current limiting characteristics of the DS1488. For a set slew rate the appropriate capacitor value may be calculated using the following relationship

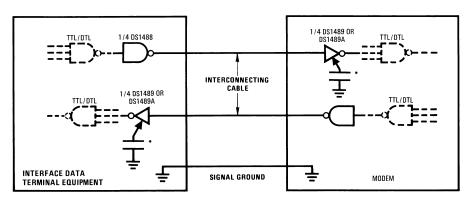
$$C = I_{SC} (\Delta T / \Delta V)$$
 (1)

where C is the required capacitor, I_{SC} is the short circuit current value, and $\Delta V/\Delta T$ is the slew rate.

RS-232C specifies that the output slew rate must not exceed 30V per microsecond. Using the worst case output short circuit current of 12 mA in the above equation, calculations result in a required capacitor of 400 pF connected to each output.

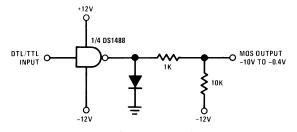
See Typical Performance Characteristics.

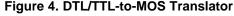
Typical Applications



Optional for noise filtering

Figure 3. RS-232C Data Transmission





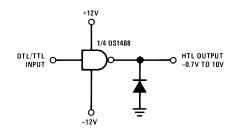


Figure 5. DTL/TTL-to-HTL Translator

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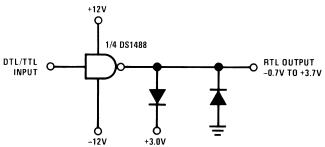
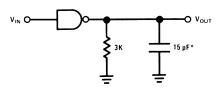
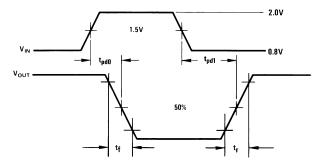


Figure 6. DTL/TTL-to-RTL Translator

AC Load Circuit and Switching Time Waveforms



*C_L includes probe and jig capacitance.



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 t_{r} and t_{f} are measured between 10% and 90% of the output waveform.

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Typical Performance Characteristics

T_A=+25°C unless otherwise noted

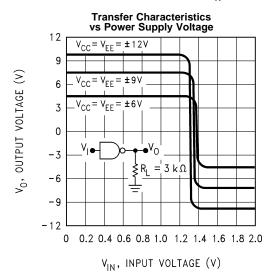


Figure 7.

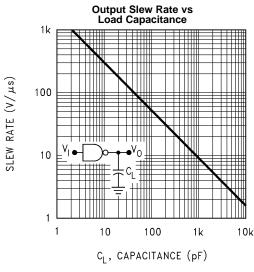
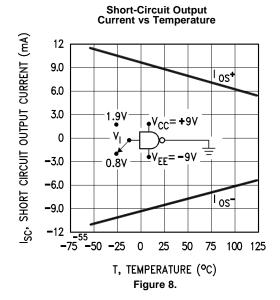


Figure 9.



Output Voltage and Current-Limiting Characteristics

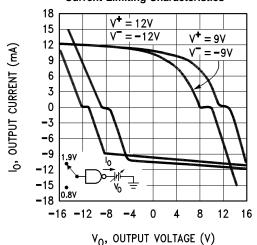


Figure 10.

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REVISION HISTORY	
Changes from Revision B (April 2013) to Revision C	Page

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